



Winstar Display Co., LTD

華凌光電股份有限公司



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SPECIFICATION

CUSTOMER : _____

MODULE NO.: WX12864AP2-YFH

<p>APPROVED BY:</p> <p>(FOR CUSTOMER USE ONLY)</p>	<p>PCB VERSION: _____</p> <p>DATA: _____</p>
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SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
ISSUED DATE: _____			



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MODLE NO :

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2006.06.30		First issue

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1. Module Classification Information

W X 1 2 8 6 4 A P 2 - Y F H
 ① ② ③ ④ ⑤ ⑥ ⑦

- ① Brand : WINSTAR DISPLAY CORPORATION
- ② Display Type : H→Character Type, G→Graphic Type
- ③ Display Font : Graphic 128*64 Dots
- ④ Model serials no.
- ⑤ Backlight Type : N→Without backlight P→LED, Bule
 B→EL, Blue green A→LED, Amber
 D→EL, Green R→LED, Red
 W→EL, White O→LED, Orange
 F→CCFL, White G→LED, Green
 Y→LED, Yellow Green T→LED, White
- ⑥ LCD Mode : B→TN Positive, Gray T→FSTN Negative
 N→TN Negative,
 G→STN Positive, Gray
 Y→STN Positive, Yellow Green
 M→STN Negative, Blue
 F→FSTN Positive
- ⑦ LCD Polarizer Type/ A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00
 Temperature range/ D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00
 View direction G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00
 J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00
 B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00
 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00
- ⑧ Special Code

2. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.

3. General Specification

Item	Dimension	Unit
Number of Characters	128 x 64	—
Module dimension	66.5*38.0*9.3(MAX)	mm
View area	17.98*29.58	mm
Active area	15.98*25.58	mm
Dot size	0.18 x 0.23	mm
Dot pitch	0.2 x 0.25	mm
LCD type	FSTN Positive , Transflective	
Duty	1/64	
View direction	6 o'clock	
Backlight Type	LED, Yellow Green	

4. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	T_{OP}	-20	—	+70	°C
Storage Temperature	T_{ST}	-30	—	+80	°C
Input Voltage	V_I	V_{SS}	—	V_{DD}	V
Supply Voltage For Logic	$V_{DD}-V_{SS}$	2.4	—	3.6	V
Supply Voltage For LCD	V_O-V_{SS}	4.0	—	15.0	V

5. Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	$V_{DD}-V_{SS}$	—	3.0	3.3	3.6	V
Supply Voltage For LCD	$V_{DD}-V_O$	$T_a=-20^{\circ}\text{C}$	—	—	10.5	V
		$T_a=25^{\circ}\text{C}$	—	8.2	—	V
		$T_a=+70^{\circ}\text{C}$	6.8	—	—	V
Input High Volt.	V_{IH}	—	$0.8 V_{DD}$	—	V_{DD}	V
Input Low Volt.	V_{IL}	—	—	—	$0.2 V_{DD}$	V
Output High Volt.	V_{OH}	—	$V_{DD} - 0.4$	—	—	V
Output Low Volt.	V_{OL}	—	—	—	0.4	V
Supply Current	I_{DD}	$V_{DD}=3.3\text{V}$	0.8	1.0	1.2	mA

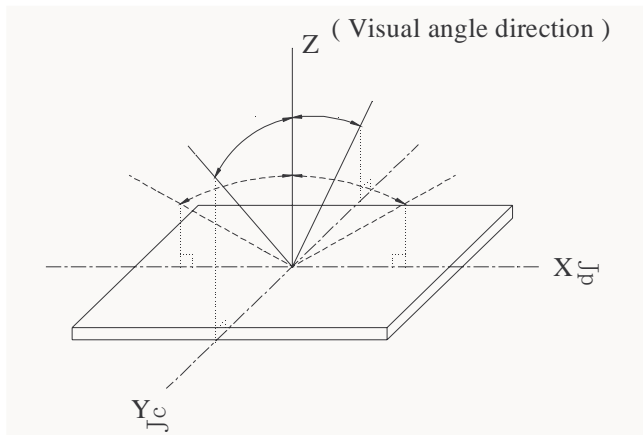
* The module using three-times boosting circuit and using internal temperature compensation.

6. Optical Characteristics

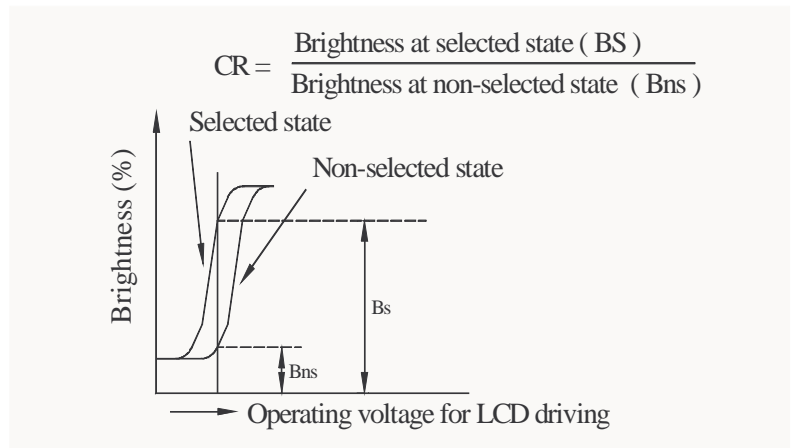
Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V) θ	$CR \geq 5$	30	—	60	deg
	(H) ϕ	$CR \geq 5$	-45	—	45	deg
Contrast Ratio	CR	—	—	5	—	—
Response Time	T rise	—	—	110	220	ms
	T fall	—	—	260	520	ms

6.1 Definitions

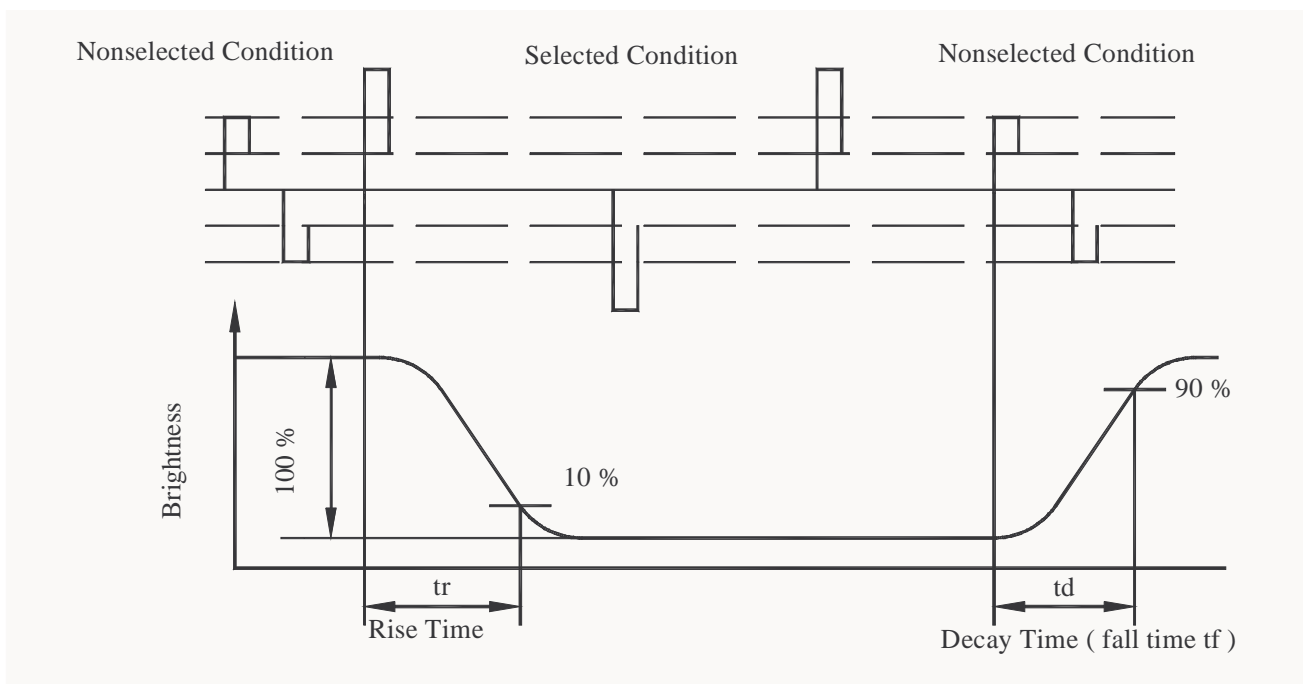
■ View Angles



■ Contrast Ratio



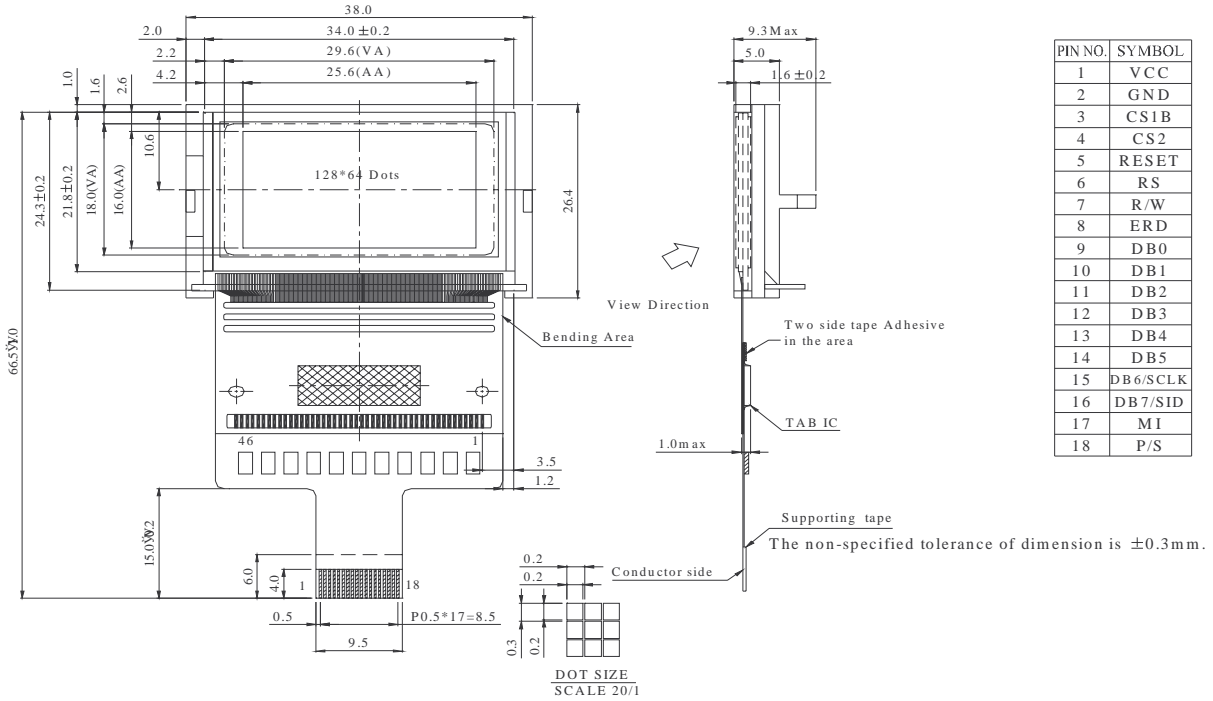
■ Response Time



7. Interface Description

Pin No.	Symbol	I/O	Description															
1	VDD	—	Power supply pin for logic.															
2	VSS	—	Ground pin, connected to 0V															
3	CS1B	I	Chip select input pins Data/instruction i/o is enabled only when CS1Bis”L”and CS2”H”. When chip select is non-active,DB0 TO DB7 may be high impedance.															
4	CS2	I	Chip select input pins Data/instruction i/o is enabled only when CS1Bis”L”and CS2”H”. When chip select is non-active,DB0 TO DB7 may be high impedance.															
5	RES	I	Reset input pin When RESETB is “L”, initialization is executed.															
6	RS	I	Register select input pin -RS = “H”:DB0 to DB7 are display data -RS = “L” :DB0 to DB7 are control data															
7	R/W	I	When connected to 80-family MPU: Write enable clock input pin. The data ON DB0~DB7 are latched at the rising edge of the /WR signal. When connected to 68-family MPU: RW = ”H”: read RW = “L”: write															
8	E	I	When connected to 80-family MPU: Read enable clock input pin. When /RD is “L”, DB0~DB7 are in an output status When connected to 68-family MPU: RW = ”H”: When E is “H”, DB0~DB7 are in an output status RW = “L”: The data on DB0~DB7 are latched at the falling edge of the E signal															
9~16	DB0~DB7	I/O	8-bit bi-directional data bus that is connected to the standard 8-bit microprocessor data bus. When the serial interface selected(PS=”L”) DB0~DB5: high impedance DB6: serial input clock (SCLK) DB7: serial input data (SID) When chip select is not active, DB0~DB7 may be high impedance.															
17	MI	I	Microprocessor interface selects pin. MI=”H”: 6800-series MPU interface MI=”L”: 8080-series MPU interface															
18	PS	I	Parallel/Serial data input select pin. <table border="0" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;"></td> <td style="width: 20%; text-align: center;">Interface</td> <td style="width: 20%; text-align: center;">Data</td> <td style="width: 20%; text-align: center;">Read/Write</td> <td style="width: 20%; text-align: center;">Serial clock</td> </tr> <tr> <td>PS=”H”:</td> <td>Parallel</td> <td>DB0~DB7</td> <td>E_RD,RW_WR</td> <td>-</td> </tr> <tr> <td>PS=”L”:</td> <td>Serial</td> <td>SID(DB7)</td> <td>Write only</td> <td>SCLK(DB6)</td> </tr> </table> In serial mode, it is impossible to read data from the on-chip RAM. And DB0 to DB5 are high impedance and E_RD and RW_WR must be fixed to either “H” or “L”.		Interface	Data	Read/Write	Serial clock	PS=”H”:	Parallel	DB0~DB7	E_RD,RW_WR	-	PS=”L”:	Serial	SID(DB7)	Write only	SCLK(DB6)
	Interface	Data	Read/Write	Serial clock														
PS=”H”:	Parallel	DB0~DB7	E_RD,RW_WR	-														
PS=”L”:	Serial	SID(DB7)	Write only	SCLK(DB6)														

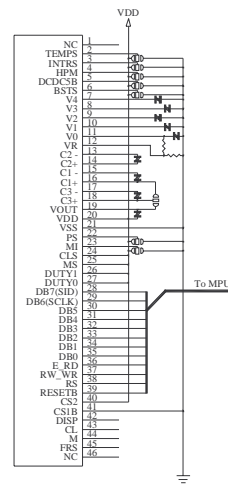
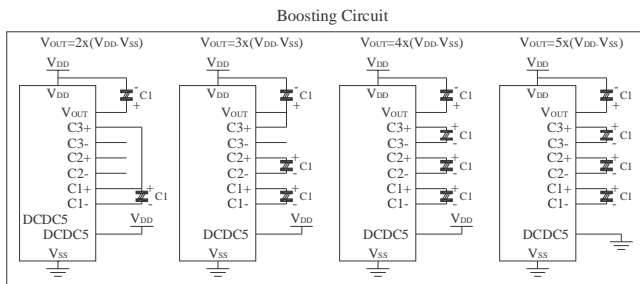
8. Contour Drawing & Block Diagram



PIN NO.	SYMBOL
1	VCC
2	GND
3	CS1B
4	CS2
5	RESET
6	RS
7	R/W
8	ERD
9	DB0
10	DB1
11	DB2
12	DB3
13	DB4
14	DB5
15	DB6/SCLK
16	DB7/SID
17	M1
18	P/S

Display Data RAM

Page Address P3,P2,P1,P0	Data	RAM address	Line Address (HEX)	Com Output
0,0,0,0	DB0		00	COM1
	DB1		01	COM2
	DB2		02	COM3
	DB3		03	COM4
	DB4		04	COM5
	DB5		05	COM6
	DB6		06	COM7
	DB7		07	COM8
?			?	?
0,1,1,1	DB0		38	COM57
	DB1		39	COM58
	DB2		3A	COM59
	DB3		3B	COM60
	DB4		3C	COM61
	DB5		3D	COM62
	DB6		3E	COM63
	DB7		3F	COM64
0,1,1,1	DB0		40	COM65
Column Address	ADC=0	83 82 81 80 7F 7E 7D 7C 7B 7A	~	5 4 3 2 1 0
Address	ADC=1	0 1 2 3 4 5 6 7 8 9	7E 7F 80 81 82 83	
Segment Output		33 31 30 29 28 27 26 25 24 23 22 21	~	6 5 4 3 2 1



Application Circuit

9.Backlight Information

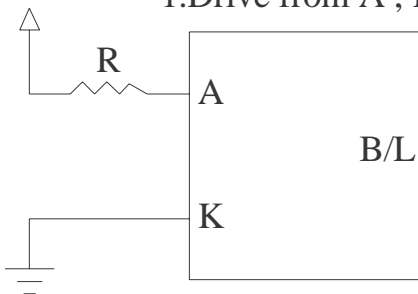
Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	I _{LED}	64	80	120	mA	V=4.2V
Supply Voltage	V	4.0	4.2	4.4	V	—
Reverse Voltage	V _R	—	—	8	V	—
Luminous Intensity	I _V	130	190	—	CD/M ²	I _{LED} =80mA
Wave Length	λ _p	560	570	580	nm	I _{LED} =80mA
Life Time	—	—	100K	—	Hr.	I _{LED} ≤ 80mA
Color	Y/G					

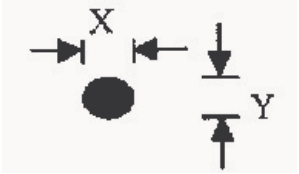
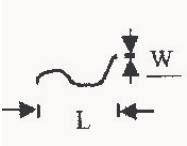
Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

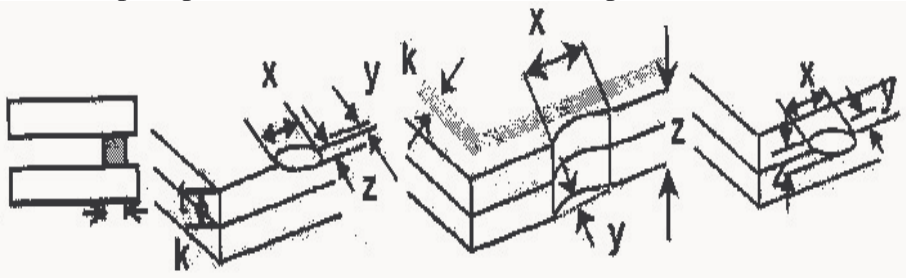
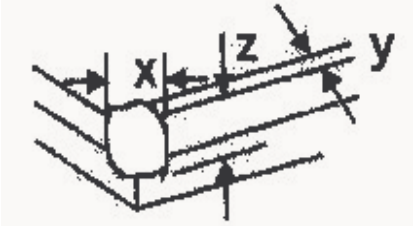
LED B\L Drive Method

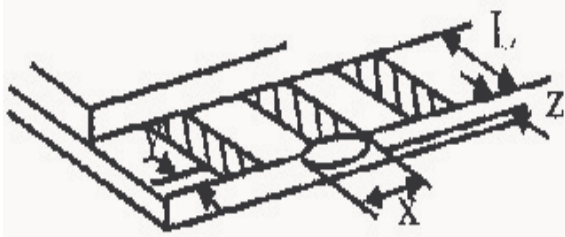
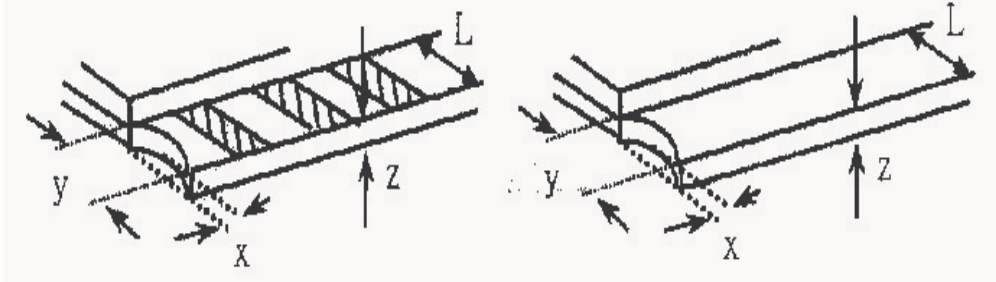
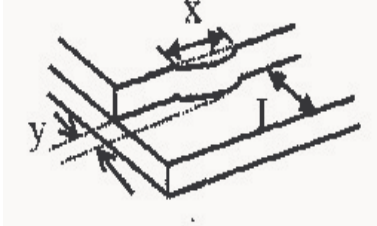
1. Drive from A , K

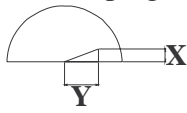


10. Inspection specification

NO	Item	Criterion	AQL																								
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.	0.65																								
02	Black or white spots on LCD (display only)	2.1 White and black spots on display $\leq 0.25\text{mm}$, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm	2.5																								
03	LCD black spots, white spots, contamination (non-display)	<p>3.1 Round type : As following drawing</p> $\Phi = (x + y) / 2$  <table border="1" data-bbox="826 846 1305 1238"> <thead> <tr> <th>SIZE</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.10$</td> <td>Accept no dense</td> </tr> <tr> <td>$0.10 < \Phi \leq 0.20$</td> <td>2</td> </tr> <tr> <td>$0.20 < \Phi \leq 0.25$</td> <td>1</td> </tr> <tr> <td>$0.25 < \Phi$</td> <td>0</td> </tr> </tbody> </table> <p>3.2 Line type : (As following drawing)</p>  <table border="1" data-bbox="659 1294 1305 1550"> <thead> <tr> <th>Length</th> <th>Width</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td>---</td> <td>$W \leq 0.02$</td> <td>Accept no dense</td> </tr> <tr> <td>$L \leq 3.0$</td> <td>$0.02 < W \leq 0.03$</td> <td rowspan="2">2</td> </tr> <tr> <td>$L \leq 2.5$</td> <td>$0.03 < W \leq 0.05$</td> </tr> <tr> <td>---</td> <td>$0.05 < W$</td> <td>As round type</td> </tr> </tbody> </table>	SIZE	Acceptable Q TY	$\Phi \leq 0.10$	Accept no dense	$0.10 < \Phi \leq 0.20$	2	$0.20 < \Phi \leq 0.25$	1	$0.25 < \Phi$	0	Length	Width	Acceptable Q TY	---	$W \leq 0.02$	Accept no dense	$L \leq 3.0$	$0.02 < W \leq 0.03$	2	$L \leq 2.5$	$0.03 < W \leq 0.05$	---	$0.05 < W$	As round type	2.5
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$0.25 < \Phi$	0																										
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$L \leq 2.5$	$0.03 < W \leq 0.05$																										
---	$0.05 < W$	As round type																									
04	Polarizer bubbles	<p>If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.</p> <table border="1" data-bbox="794 1639 1305 2011"> <thead> <tr> <th>Size Φ</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.20$</td> <td>Accept no dense</td> </tr> <tr> <td>$0.20 < \Phi \leq 0.50$</td> <td>3</td> </tr> <tr> <td>$0.50 < \Phi \leq 1.00$</td> <td>2</td> </tr> <tr> <td>$1.00 < \Phi$</td> <td>0</td> </tr> <tr> <td>Total Q TY</td> <td>3</td> </tr> </tbody> </table>	Size Φ	Acceptable Q TY	$\Phi \leq 0.20$	Accept no dense	$0.20 < \Phi \leq 0.50$	3	$0.50 < \Phi \leq 1.00$	2	$1.00 < \Phi$	0	Total Q TY	3	2.5												
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$0.50 < \Phi \leq 1.00$	2																										
$1.00 < \Phi$	0																										
Total Q TY	3																										

NO	Item	Criterion	AQL																		
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination																			
06	Chipped glass	<p>Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length:</p> <p>6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels:</p>  <table border="1" data-bbox="395 981 1305 1182"> <thead> <tr> <th>z: Chip thickness</th> <th>y: Chip width</th> <th>x: Chip length</th> </tr> </thead> <tbody> <tr> <td>$Z \leq 1/2t$</td> <td>Not over viewing area</td> <td>$x \leq 1/8a$</td> </tr> <tr> <td>$1/2t < z \leq 2t$</td> <td>Not exceed 1/3k</td> <td>$x \leq 1/8a$</td> </tr> </tbody> </table> <p>⊙If there are 2 or more chips, x is total length of each chip.</p> <p>6.1.2 Corner crack:</p>  <table border="1" data-bbox="395 1619 1305 1821"> <thead> <tr> <th>z: Chip thickness</th> <th>y: Chip width</th> <th>x: Chip length</th> </tr> </thead> <tbody> <tr> <td>$Z \leq 1/2t$</td> <td>Not over viewing area</td> <td>$x \leq 1/8a$</td> </tr> <tr> <td>$1/2t < z \leq 2t$</td> <td>Not exceed 1/3k</td> <td>$x \leq 1/8a$</td> </tr> </tbody> </table> <p>⊙If there are 2 or more chips, x is the total length of each chip.</p>	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	2.5
z: Chip thickness	y: Chip width	x: Chip length																			
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$																			
$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$																			
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$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$																			
$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$																			

NO	Item	Criterion	AQL						
06	Glass crack	<p>Symbols :</p> <p>x: Chip length y: Chip width z: Chip thickness</p> <p>k: Seal width t: Glass thickness a: LCD side length</p> <p>L: Electrode pad length</p> <p>6.2 Protrusion over terminal :</p> <p>6.2.1 Chip on electrode pad :</p>	2.5						
									
		<table border="1" data-bbox="304 801 1220 965"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td>$y \leq 0.5\text{mm}$</td> <td>$x \leq 1/8a$</td> <td>$0 < z \leq t$</td> </tr> </table>		y: Chip width	x: Chip length	z: Chip thickness	$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$
		y: Chip width		x: Chip length	z: Chip thickness				
$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$							
<p>6.2.2 Non-conductive portion:</p> 									
<table border="1" data-bbox="376 1294 1220 1462"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td>$y \leq L$</td> <td>$x \leq 1/8a$</td> <td>$0 < z \leq t$</td> </tr> </table>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$			
y: Chip width	x: Chip length	z: Chip thickness							
$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$							
<p>⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</p> <p>⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged.</p>									
<p>6.2.3 Substrate protuberance and internal crack.</p>  <table border="1" data-bbox="715 1727 1225 1888"> <tr> <td>y: width</td> <td>x: length</td> </tr> <tr> <td>$y \leq 1/3L$</td> <td>$x \leq a$</td> </tr> </table>	y: width	x: length	$y \leq 1/3L$	$x \leq a$					
y: width	x: length								
$y \leq 1/3L$	$x \leq a$								

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong.	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB  $X * Y \leq 2\text{mm}^2$	2.5 2.5 0.65 2.5 0.65 0.65 2.5 2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.	2.5
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	0.65
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	0.65



Module Number : _____

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1、 Panel Specification :

- 1. Panel Type : Pass NG , _____
- 2. View Direction : Pass NG , _____
- 3. Numbers of Dots : Pass NG , _____
- 4. View Area : Pass NG , _____
- 5. Active Area : Pass NG , _____
- 6. Operating Temperature : Pass NG , _____
- 7. Storage Temperature : Pass NG , _____
- 8. Others : _____

2、 Mechanical Specification :

- 1. PCB Size : Pass NG , _____
- 2. Frame Size : Pass NG , _____
- 3. Material of Frame : Pass NG , _____
- 4. Connector Position : Pass NG , _____
- 5. Fix Hole Position : Pass NG , _____
- 6. Backlight Position : Pass NG , _____
- 7. Thickness of PCB : Pass NG , _____
- 8. Height of Frame to PCB : Pass NG , _____
- 9. Height of Module : Pass NG , _____
- 10. Others : Pass NG , _____

3、 Relative Hole Size :

- 1. Pitch of Connector : Pass NG , _____
- 2. Hole size of Connector : Pass NG , _____
- 3. Mounting Hole size : Pass NG , _____
- 4. Mounting Hole Type : Pass NG , _____
- 5. Others : Pass NG , _____

4、 Backlight Specification :

- 1. B/L Type : Pass NG , _____
- 2. B/L Color : Pass NG , _____
- 3. B/L Driving Voltage (Reference for LED Type) : Pass NG , _____
- 4. B/L Driving Current : Pass NG , _____
- 5. Brightness of B/L : Pass NG , _____
- 6. B/L Solder Method : Pass NG , _____
- 7. Others : Pass NG , _____

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Module Number : _____

5、Electronic Characteristics of Module :

- 1. Input Voltage : Pass NG , _____
- 2. Supply Current : Pass NG , _____
- 3. Driving Voltage for LCD : Pass NG , _____
- 4. Contrast for LCD : Pass NG , _____
- 5. B/L Driving Method : Pass NG , _____
- 6. Negative Voltage Output : Pass NG , _____
- 7. Interface Function : Pass NG , _____
- 8. LCD Uniformity : Pass NG , _____
- 9. ESD test : Pass NG , _____
- 10. Others : Pass NG , _____

6、Summary :

Sales signature : _____

Customer Signature : _____

Date : / /